

7U Series SMD Crystal Units

Seam Sealed Ceramic Size: 3225 (3.2x2.5x0.7mm) 10 to 64 Mhz / 10ppm~30ppm

Features

- 3225 size ultra miniature and lightweight SMD crystal units with low profile of 0.7mm
- Frequency range from 10MHz to 64MHz
- High precision and high frequency stability
- Allowing for high density surface mounting
- Automatic mounting and reflow soldering
- Application for wireless communications, PC, IPAD, PDA, Wearable device, etc.
- RoHS Compliant /Pb Free



Standard Specification

Item /Type	7U Series		
Frequency Range	10~64 MHz		
Frequency Tolerance (at 25°C)	±10ppm~±30ppm, or specify		
Frequency stability Over Operating Temperature	±10ppm~±30ppm, or specify		
Operating Temperature Range	-40~+85°C, or specify		
Shunt Capacitance (C ₀)	5pF Max.		
Drive Level	1~200μW (100μW Typ.)		
Load Capacitance	8pF, 10pF, 12 pf or specify		
Aging (at 25°C)	±3ppm /year Max.		
Storage Temperature Range	-55~+125°C		
Packing Unit	3000pcs.		

Equivalent Series Resistance

Fundamental					
10~16 MHz	100Ω Max.				
16~20 MHz	80Ω Max.				
20~64 MHz	60Ω Max.				

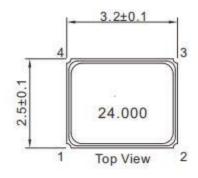


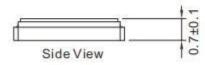
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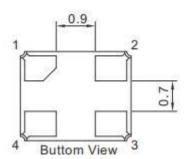
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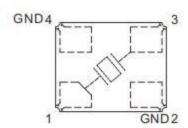
10 to 64 Mhz / 10ppm~30ppm

Dimensions (mm)

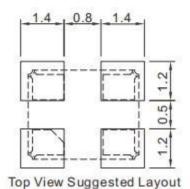








Top View Crystal Connection



Part ordering information

X	-7U	-26.000	-9	-10	-60	-C	-10
	Series	Frequency	Load Capacitance	Frequency Tolerance	ESR	Operating T°	Frequency Stability
		e.g.:	e.g.:	e.g.:	e.g.:	$A = -10 \sim +60 ^{\circ}C$	e.g.:
		26.000 = 26MHz	9 = 9pF	10 = 10ppm	$60 = 60\Omega \text{ max}$	B = -20~+70°C	$10 = \pm 10$ ppm
						C = -40~+85°C	
						D = -40~+105°C	
						E = -55~+125°C	



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